

# CAT32 CMOS White LED Driver

### **FEATURES**

- Low quiescent ground current (0.5mA typical)
- Power efficiency over 80%
- Compatible pinout with LT1932
- Adjustable output current (up to 40mA)
- High frequency 1.2MHz operation
- Input voltage operation down to 2.0V
- Low resistance (0.5Ω) high voltage power switch

### **APPLICATIONS**

- Color LCD and keypad backlighting
- Cellular phones
- Handheld terminals

### DESCRIPTION

The CAT32 is a DC/DC step up converter that delivers a regulated output current. Operation at a constant switching frequency of 1.2MHz allows the device to be used with very small value external inductor and ceramic capacitors.

The CAT32 is targeted to drive multiple white lightemitting diodes (LEDs) connected in series and provides the necessary regulated current to control the brightness and the color purity. An external resistor  $R_{SET}$  controls the output current level. LED currents of up to 40mA can be supported over a wide range of input supply voltages from 2V to 7V, making the device ideal for battery-powered applications. Drives up to 4 White LEDs in series

- Shutdown current less than 1µA
- Load fault protection against open-circuits
- Low value external components
- Low profile (1mm) 6-lead SOT23 and TDFN (0.8mm) package
- Digital cameras
- PDAs/Games
- Portable MP3 players

A high voltage output stage allows up to 4 White LEDs to be driven in series. Series drive provides inherent current matching.

LED dimming can be done by using a DC voltage, a logic signal, or a pulse width modulation (PWM) signal. The shutdown input pin allows the device to be placed in power-down mode with "near zero" quiescent current.

In addition to overcurrent limiting protection, the device also includes detection circuitry to ensure protection against open-circuit load fault conditions.

The device is available in a low profile (1mm max height) 6-lead thin SOT23 package and in a TDFN (0.8mm max height) package.



Figure 1. Li-Ion Driver for Four High-Brightness White LEDs

### **ORDERING INFORMATION**

Part Number	Package	Tube Quantity	Reel Quantity	Package Marking Code
CAT32EKT-TE7	6-lead, thin SOT23	_	3000	BD
CAT32RD4-TE7	8-pad TDFN (3x3mm)	_	3500	CCEM
CAT32RD4	8-pad TDFN (3x3mm)	120	_	CCEM
CAT32TDI-TE7	6-lead thin SOT23, Lead Free	_	3000	LL

Power 1 GROUND 1

VIN [2]

SHDN [3]

RSET 4]

# **PIN CONFIGURATION**



1mm maximum height

 $\theta_{JA} = 250^{\circ}C/W$ [Free Air]

### **PIN DESCRIPTIONS**

Dia Number		
TDFN	Name	Function
8	SW	Switch pin. This is the drain of the internal power switch. For minimum EMI, minimize the trace area connected to this pin.
5	GND	Ground pin. Connect pin 2 to ground.
6	LED	LED (cathode) connection pin.
4	RSET	RESET pin. A resistor connected from pin 4 to ground sets the LED current. This pin is also used to dim the LEDs.
3	SHDN	Shutdown pin.
2	VIN	Input supply pin. This pin should be bypassed with a capacitor to ground. A $4.7\mu$ F capacitor mounted close to the pin is recommended.
1	Power	Power Ground
	8 5 6 4 3	TDFNName8SW5GND6LED4RSET3SHDN2VIN

(Top View)

TDFN Package: 3mm x 3mm 0.8mm maximum height

(RD4)

[8] sw

[7] NC

[6] LED

[5] GND

### **ABSOLUTE MAXIMUM RATINGS**

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

V <sub>IN</sub> , LED, SHDN Voltage 8V	
SW Voltage 20V	
RSET Voltage 1V	
Junction Temperature 125°C	

Lead Soldering Temperature (10 secs)	300°C
Storage Temperature65°C to	150°C
ESD Rating - Human Body Model	2000V

### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Range	Unit	
V <sub>IN</sub>	2 to 7	V	
Ambient Temperature Range	-40 to +85	° C	
Inductor L1	6.8 ±20% typical	μH	
Input Capacitor C1	4.7 ±20% typical	μF	
Output Capacitor C2	1.0 ±20% typical	μF	
I <sub>LED</sub> with 1 to 4 LEDs in series	0 to 20	mA	

### **ELECTRICAL SPECIFICATIONS**

Over recommended operating conditions unless otherwise specified.  $T_A = 25^{\circ}C$ ,  $V_{IN} = 2V$  and  $V_{\overline{SHDN}} = 1.2V$ .

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Ι <sub>α</sub>	Quiescent Current	$V_{RSET} = 0.2V$		0.5	0.7	mA
I <sub>GND</sub>	Ground Current in Shutdown	$V_{SHDN} = 0V$		0.05	1	μA
V	LED Pin Voltage	$V_{IN} < V_{OUT}, I_{LED} = 15 \text{mA}$		120	180	mV
I <sub>LED</sub>	LED Current Adjust Range		5		40	mA
		R <sub>SET</sub> = 562Ω	33	38	45	
	Programmed LED Current	R <sub>SET</sub> = 750Ω	25	30	36	mA
LED		R <sub>set</sub> = 1.5kΩ	12.5	15	17.5	
		$R_{SET} = 4.53 k\Omega$		5		
I <sub>LED</sub>	LED Pin Current Temperature Coefficient	I <sub>LED</sub> = 15mA		-0.01		mA/° C
V <sub>rset</sub>	R <sub>set</sub> Pin Voltage	R <sub>set</sub> = 1.5kΩ		100		mV
	Shutdown Pin Logic High Level		0.85			V
	Shutdown Pin Logic Low Level				0.25	V
f <sub>sw</sub>	Boost Converter Frequency		0.8	1.2	1.6	MHz
I <sub>SWL</sub>	Switch Current Limit		400	550	780	mA
		V <sub>IN</sub> = 2V, I <sub>SW</sub> = 100mA		0.7	1.2	Ω
R <sub>sw</sub>	Switch Resistance	V <sub>IN</sub> = 3V, I <sub>SW</sub> = 100mA		0.5	0.9	Ω
	Switch Leakage Current	Switch Off, $V_{sw} = 5V$		0.01	5	μA
	Efficiency	Components shown on Figure 1		83		%

# **TYPICAL CHARACTERISTICS**

 $V_{IN}$ =3.6V,  $T_{AMB}$ =25°C,  $C_{IN}$ =4.7 $\mu$ F,  $C_{OUT}$ =1 $\mu$ F, L=6.8 $\mu$ H, unless otherwise specified.





# **TYPICAL CHARACTERISTICS**

 $V_{IN}=3.6V, T_{AMB}=25^{\circ}C,\ C_{IN}=4.7\mu F,\ C_{OUT}=1\mu F,\ L=6.8\mu H,\ unless\ otherwise\ specified.$ 



Efficiency vs. Input Voltage





Vsw, IL, & Vout Signal Waveforms



PWM on SHDN pin Waveform



## OPERATION

The CAT32 device is a high efficiency, constant frequency, current regulating boost converter.

The device includes a switch and an internally compensated loop for the regulation of the LED current.

Operation can be best understood by examining the block diagram. The RSET pin is regulated at 100mV and the current through the external resistor will set the regulated current in the LEDs (from 5mA to 40mA) with a multiplication factor of 225.

While maintaining LED current regulation, the CAT32 automatically adjusts the LED pin voltage to be as low as

possible. A low LED pin voltage ensures high efficiency.

Current through the internal power switch is continuously monitored cycle-by-cycle. If the current limit is exceeded, the switch is immediately turned off, protecting the device, for the remainder of the cycle.

PWM dimming operation can be achieved by switching the  $\overline{SHDN}$  pin or by pulling the RSET pin higher than 0.1V.

#### L1 D1 Vin o C1 SW Over Voltage 1.2 MHz Protection Oscillator (22V) LED PWM & Logic 3 LED **CAT32** Current Sense \mp 100mV 6 VIN Current SHDN 5 Control ILED = 225 x IS SOT23 Pin Numbers 225x ١s RSET GND 2 4 RSET

### **BLOCK DIAGRAM**

Figure 2. CAT32 Block Diagram

# **APPLICATION INFORMATION**

#### Inductor Selection and Efficiency

Inductor vendors are shown below. Contact the manufacturer for detailed technical data and new product information.

Inductor	<b>L (μΗ)</b>	Maximum DCR (mΩ)	Maximum Height (mm)	Vendor	Web
ELJEA4R7	4.7	180	2.2	Panasonic	
ELJEA6R8	6.8	250	2.2	714.373.7334	www.panasonic.com
LQH3C4R7M24,	4.7	260	2.2		
LQH32CN4R7M11				Murata	
LQH3C100K24,	10	300	2.2	770.436.1300	www.murata.com
LQH32CN100K11					
LB2016B4R7	4.7	250	2.0	Taiyo Yuden	
LB2016B100	3.8	350	2.0	408.573.4150	www.t-yuden.com
CMD4D06-4R7	4.7	216	0.8		
CMD4D06-6R8	6.8	296	0.8	Sumida	
CLQ4D10-4R7	4.7	162	1.2	847.956.0666	www.sumida.com
CLQ4D10-6R8	6.8	195	1.2		

### Table 1: Inductor Manufacturers

### CAPACITOR SELECTION

Low ESR (equivalent series resistance) capacitors should be used at the output to minimize the output ripple voltage. The low ESR and small package options available with multilayer ceramic capacitors make them excellent choices. The X5R and X7R capacitor types are preferred because they retain their capacitance over wider voltage and temperature ranges than the Y5V or Z5U types. A  $1.0\mu$ F or  $2.2\mu$ F output capacitor is recommended for most applications.

The voltage rating of the output capacitor C2 depends on the number of LEDs driven in series. A 10V ceramic capacitor is recommended when driving two LEDs. A 16V ceramic capacitor is recommended when driving 3 or 4 LEDs. Low profile ceramic capacitors with a 1mm maximum height/thickness are available for designs height requirements. Ceramic capacitors also make a good choice for the input capacitor, which should be mounted as close as possible to the CAT32. A  $2.2\mu$ F or  $4.7\mu$ F input capacitor is recommended. Table 2 shows a list of several ceramic capacitor manufacturers. Consult the manufacturers for detailed information as new products and package options are introduced regularly.

<b>Table 2: Ceramic Capacitor Manufacturers</b>
-------------------------------------------------

Supplier	Phone	Web
Taiyo Yuden	408.573.4150	www.t-yuden.com
Murata	814.237.1431	www.murata.com
Kemet	408.986.0424	www.kemet.com

### **DIODE SELECTION**

Schottky diodes, with their low forward voltage drop and fast switching speed, are the ideal choice for high efficiency applications. Table 3 shows several different Schottky diodes that work well with the CAT32. Make sure that the diode has a voltage rating greater than the output voltage. The diode conducts current only when the power switch is turned off (typically less than onethird the time), so a 0.4A or 0.5A diode will be sufficient for most designs.

#### Table 3: Schottky Diode Suppliers

Part	Supplier
MBR0520	ON Semiconductor
MBR0530	www.onsemi.com
MBR0540	800.282.9855
ZHCS400	Zetex

#### LED CURRENT PROGRAMMING

The LED current is programmed with a single resistor connected to the RSET pin The RSET pin is internally regulated to 100mV, which sets the current flowing out of this pin, ISET, equal to 100mV/RSET. The CAT32

I <sub>LED</sub> (mA)	RSET
40	562Ω
30	750Ω
25	909Ω
20	1.13kΩ
15	1.50kΩ
10	2.26kΩ
5	4.53kΩ

#### Table 4: RSET Resistor Values

For other LED current values, use the following equation to choose R<sub>SET</sub>.

$$R_{\text{SET}} = 225 \times \left(\frac{0.1V}{I_{\text{LED}}}\right)$$

Most white LEDs are driven at maximum currents of 15mA to 20mA. Some higher power designs will use two parallel strings of LEDs for greater light output, resulting in 30mA to 40mA (two strings of 15mA to 20mA) flowing into the LED pin.

regulates the current into the LED pin,  $I_{LED}$ , to 225 times the value of ISET. For the best accuracy, a 1% or better resistor is recommended. Table 4 shows several typical 1%  $R_{SET}$  values.

#### LED DIMMING WITH PWM SIGNAL

PWM brightness control provides the widest dimming range (greater than 20:1). By turning the LEDs ON and OFF using the control signal the LEDs operate at either zero or full current, but their average current changes with the PWM signal duty cycle. Typically, a 5kHz to 40kHz PWM signal is used. PWM dimming with the CAT32 can be accomplished two different ways.

The SHDN pin can be driven directly or a resistor can be added to drive the RSET pin. If the SHDN pin is used, increasing the duty cycle will increase the LED brightness. Using this method, the LEDs can be dimmed and turned off completely using the same control signal. A 0% duty cycle signal will turn off the CAT32, reducing the total quiescent current to near zero.

If the RSET pin is used, increasing the duty cycle will decrease the brightness. Using this method, the LEDs are dimmed using RSET and turned off completely using SHDN. If the RSET pin is used to provide PWM dimming, the approximate value of R<sub>PWM</sub> should be calculated (where V<sub>MAX</sub> is the "HIGH" value of the PWM signal):

$$R_{PWM} = R_{SET} \times \left(\frac{V_{MAX}}{0.15V} - 1\right)$$

#### LED DIMMING WITH A LOGIC SIGNAL

For applications that need to adjust the LED brightness in discrete steps, a logic signal can be used.  $R_{MIN}$  sets the minimum LED current value (when the NMOS is OFF):

$$R_{MIN} = 225 \times \left(\frac{0.1V}{I_{LED(MIN)}}\right)$$

#### LED DIMMING WITH A DC VOLTAGE

In addition to providing the widest dimming range, PWM brightness control also ensures the "purest" white LED color over the entire dimming range. The true color of a white LED changes with operating current, and is the "purest" white at a specific forward current, usually 15mA or 20mA. If the LED current is less than or more than this value, the emitted light becomes more blue. Applications involving color LCDs can find the blue tint objectionable.

When a PWM control signal is used to drive the SHDN pin of the CAT32, the LEDs are turned off and on at the PWM frequency. The current through them alternates between full current and zero current, so the average current changes with duty cycle. This ensures that when the LEDs are on, they can be driven at the appropriate current to give the purest white light. LED brightness varies linearly with the PWM duty cycle.

R<sub>INCR</sub> determines how much LED current increases when the external NMOS switch is turned ON.

$$\mathsf{R}_{\mathsf{INCR}} = 225 \times \left(\frac{0.1\mathsf{V}}{\mathsf{I}_{\mathsf{LED}(\mathsf{Increase})}}\right)$$



Figure 3: LED Dimming Circuits

### PCB LAYOUT GUIDELINES

The CAT32 is a high-frequency switching regulator and therefore proper PCB board layout and component placement can minimize noise and radiation and increase efficiency. To maximize efficiency, the CAT32 design has fast switch rise and fall times. To prevent radiation and high frequency resonance problems minimize the length and area of all traces connected to the SW pin and use a ground plane under the switching regulator.

The switch, schottky output diode and output capacitor signal path should be kept as short as possible. The ground connection for the  $R_{SET}$  resistor should be tied directly to the GND pin and not be shared with other components.

### **TYPICAL APPLICATION CIRCUITS**

The application diagrams below are shown for the SOT23 packages.

#### Two LEDs with DC Level Dimming Control:



Three LEDs with DC Level Dimming Control:

**Efficiency - Three LEDs** 





#### Efficiency - Four LEDs Four LEDs with PWM Dimming Control: L1 6.8µH D1 85 VIN-Vin = 4.2V 80 EFFICIENCY [%] 6 \_C1 −4.7µF Vin = 3.0V VIN SW 75 CAT32 70 - C2 ⁻ 1µF PWM DIMMING -CONTROL 5 SHDN LED 65 GND RSET 15mA 4 2 60 0 10 5 15 20 $\begin{cases} R_{SET} \\ 1.50k\Omega \end{cases}$ LED CURRENT [mA] Ŧ



The package top may be smaller than the package bottom. Dimensions D and E1 are determined at the outermost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body. D and E1 dimensions are determined at Datum H. <u>A</u>.

Datums A & B to be determined at Datum H.

<u>∕</u>€ ∕∧ ∕® Package varation "AB" is a 5 lead version of the 6 lead variation "AA" where lead #5 has been removed from the 6 lead "AA" variation.

These dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.

Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm total in excess of the "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot. Minimum space between protrusion and an adjacent lead shall not be less than 0.07mm.

# **TDFN 3X3 PACKAGE (RD4)**



2. COPLANARITY SHALL NOT EXCEED 0.08 mm.

3. WARPAGE SHALL NOT EXCEED 0.10 mm.

4. PACKAGE LENGTH / PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S)

5. REFER JEDEC MO-229 / WEEC

### **REVISION HISTORY**

Date	Rev.	Reason
10/9/2003	AA	Revised Typical Characteristics plots
2/11/2004	AB	Revised Efficiency plots
11/1/2004	AC	Added Green package designation
		Eliminated TDFN (3x4.9mm) package

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